

HEXFRED® Ultrafast Diodes, 100 A (INT-A-PAK Power Modules)



PRIMARY CHARACTERISTICS				
V_{R}	1200 V			
V _F (typical)	2.5 V			
t _{rr} (typical)	150 ns			
I _{F(DC)} at T _C	110 A at 100 °C			
Package	INT-A-PAK			
Circuit configuration	Two diodes doubler circuit			

FEATURES





- Standard JEDEC® package
- · Simplified mechanical designs, rapid assembly
- High surge capability
- Large creepage distances
- UL approved file E78996
- Case style INT-A-PAK
- Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Cathode to anode voltage	V_{R}		1200	V	
Continuous forward current		T _C = 25 °C	205		
	I _F	T _C = 100 °C	110	Α	
Single pulse forward current	I _{FSM}	Limited by junction temperature	800		
Maximum navvar dissination	P _D	T _C = 25 °C	695	W	
Maximum power dissipation		T _C = 100 °C	280		
RMS isolation voltage	V _{ISOL}	50 Hz, circuit to base, all terminal shorted, t = 1 s	3500	V	
Operating junction and storage temperature range	T _J , T _{Stg}		-40 to +150	°C	

ELECTRICAL SPECIFICATIONS PER LEG (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V_{BR}	Ι _R = 100 μΑ	1200	-	-	
Maximum forward voltage V _{FM}	V	I _F = 100 A	-	2.5	3.2	V
	VFM	I _F = 160 A	-	2.9	3.9	
Maximum reverse leakage current	I _{RM}	T _J = 150 °C, V _R = 1200 V	-	18	30	mA



DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Reverse recovery time	t _{rr}	T _J = 25 °C		-	150	200	ns
Reverse recovery current	I _{RRM}	T _J = 25 °C	$I_F = 160 \text{ A}$ $dI_F/dt = 200 \text{ A/}\mu\text{s}$	-	20	22	Α
Reverse recovery charge	Q _{rr}	T _J = 25 °C	$V_{\rm R} = 200 \text{ V}$	-	2000	2400	nC
Peak rate of recovery current	dI _{(rec)M} /dt	T _J = 25 °C		-	-	300	A/µs

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Junction operating and storage temperature range		T _J , T _{Stg}		-40 to +150	°C	
Maximum internal thermal r junction to case per leg	esistance,	R_{thJC}	DC operation	0.18	°C/W	
Typical thermal resistance, case to heatsink per modul	e	R _{thCS}	Mounting surface flat, smooth and greased	0.05		
Mounting torque ± 10 % busb			A mounting compound is recommended and the torque should be rechecked after a period of 3 hours	4 to 6	Nm	
			to allow for the spread of the compound.	4 10 0	INIII	
Approximate weight				200	g	
				7.1	oz.	
Case style		INT-A	-PAK			

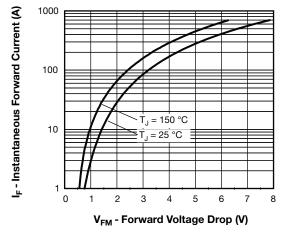


Fig. 1 - Maximum Forward Voltage Drop Characteristics

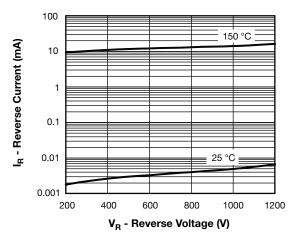


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

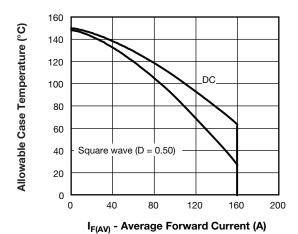


Fig. 3 - Maximum Allowable Case Temperature vs. Average Forward Current

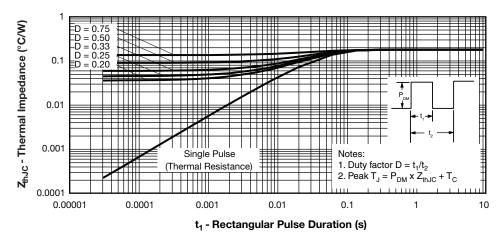


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

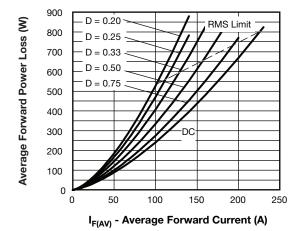


Fig. 5 - Forward Power Loss Characteristics

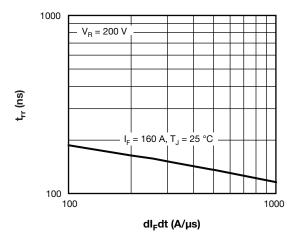


Fig. 6 - Typical Reverse Recovery Time vs. dl_F/dt (Per Leg)

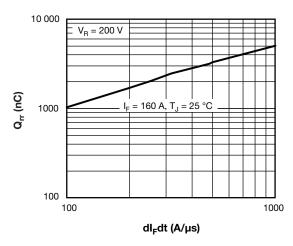


Fig. 7 - Typical Reverse Recovery Charge vs. dl_F/dt (Per Leg)

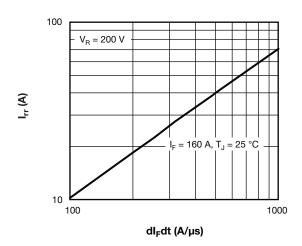
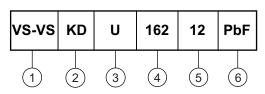


Fig. 8 - Typical Reverse Recovery Current vs. dl_F/dt (Per Leg)

ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Circuit configuration

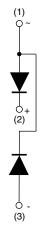
3 - U = HEXFRED® ultrafast diode

4 - Current rating

Voltage rating (12 = 1200 V)

6 - PbF = Lead (Pb)-free

CIRCUIT CONFIGURATION

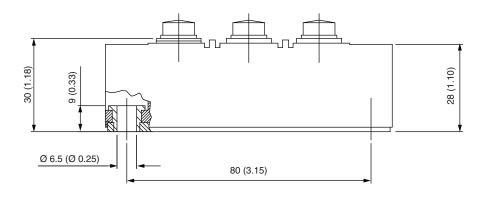


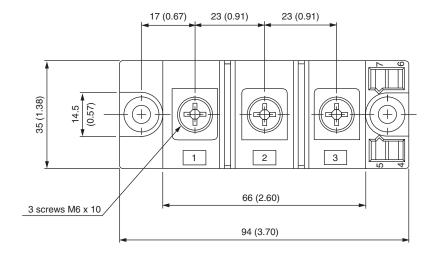
LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95254			

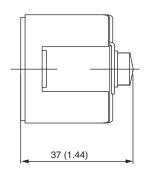


INT-A-PAK DBC

DIMENSIONS in millimeters (inches)









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